## 3.0SMCJ Series

Surface Mount - 3000W - DO-214AB











## **Additional Information**



Resources





Accessories

**Samples** 

## **Agency Approvals**

Agency	Agency File Number
91	E230531

### **Maximum Ratings and Thermal Characteristics** (T<sub>A</sub>=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation by 10/1000µs Waveform (Fig.4)(Note 1), (Note 2)	P <sub>PPM</sub>	3000	W
Power dissipation on infinite heatsink at $T_c = 25$ °C	P <sub>D</sub>	6.5	W
Peak Forward Surge Current, 8.3ms Single Half Sine Wave (Note 3)	I <sub>FSM</sub>	300	А
Maximum Instantaneous Forward Voltage at 100A for Unidirectional Only	V <sub>F</sub>	3.5	V
Operating Temperature Range	T	-65 to 150	°C
Storage Temperature Range	T <sub>STG</sub>	-65 to 175	°C
Typical Thermal Resistance Junction to Lead	$R_{\theta JL}$	15	°C/W
Typical Thermal Resistance Junction to Ambient	$R_{\theta JA}$	75	°C/W

#### Notes:

- 1. Non-repetitive current pulse , per Fig. 4 and derated above T<sub>1</sub> (initial) =25°C per Fig. 3.
- 2. Mounted on copper pad area of 0.31x0.31" (8.0 x 8.0mm) to each terminal.
- 3. Measured on 8.3ms single half sine wave or equivalent square wave for unidirectional component only, duty cycle=4 per minute maximum

## **Description**

The 3.0SMCJ Series is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

## **Features & Benefits**

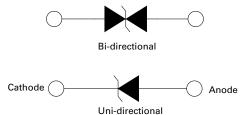
- 3000W P<sub>PPM</sub> peak pulse power capability at 10/1000µs waveform, repetition rate (duty cvcles):0.01%
- For surface mounted applications in order to optimize board space
- Low profile package
- Typical failure mode is short from over-specified voltage or
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- ESD protection of data lines in accordance with IEC 61000-4-2,30kV(Air), 30kV (Contact)
- EFT protection of data lines in accordance with IEC 61000-
- Built-in strain relief
- Glass passivated chip junction
- Fast response time: typically less than 1.0ps from 0V to BV

- Excellent clamping capability
- Low incremental surge resistance
- High temperature to reflow soldering guaranteed: 260°C/40sec
- $V_{BR} @ T_{J} = V_{BR} @ 25^{\circ}C \times (1 + \alpha T \times (T_{J} 25)) (\alpha T: Temperature)$ Coefficient, typical value is 0.1%
- UL Recognized compound meeting flammability rating
- Meet MSL level1, per J-STD-020, LF maximun peak of 260°C
- Matte tin lead-free plated
- Halogen free and RoHS compliant
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/JEDEC J-STD-609A.01)

## **Applications**

TVS components are ideal for the protection of I/O Interfaces, V<sub>cc</sub> bus and other vulnerable circuits used in Telecom, Computer, Industrial and Consumer electronic applications.

## **Functional Diagram**





## Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

Part Number (Uni)	Part Number (Bi)	Mar	king	Reverse Stand off Voltage V <sub>R</sub>	Break Volta		Test Current	@ I <sub>pp</sub>	Maximum Peak Pulse Current I <sub>pp</sub> (10/1000µs)	Maximum Clamping Voltage V <sub>c</sub>	Maximum Peak Pulse Current I <sub>pp</sub> (8/20µs)	Maximum Reverse Leakage I <sub>R</sub> @ V <sub>R</sub>	Maximum Temperature coefficient of	Agency Approval
(OIII)	(51)	UNI	ВІ	(Volts)	MIN	MAX	(mA)	(10/1000µs) (V)	(A)	(8/20µs) (V)	(A)	(μ <b>A</b> )	V <sub>BR</sub> (%/C)	
-	3.0SMCJ5.0CA	-	3DDE	5.00	6.40	7.00	10	9.2	326.1	11.89	1630.5	800	0.041	X
-	3.0SMCJ6.0CA	-	3DDG	6.00	6.67	7.37	10	10.3	291.3	13.31	1456.5	800	0.046	X
-	3.0SMCJ6.5CA	-	3DDK	6.50	7.22	7.98	10	11.2	267.9	14.47	1339.5	500	0.052	X
-	3.0SMCJ7.0CA	-	3DDM	7.00	7.78	8.60	10	12.0	250.0	15.50	1250.0	200	0.058	Χ
-	3.0SMCJ7.5CA	-	3DDP	7.50	8.33	9.21	1	12.9	232.6	16.67	1163.0	100	0.061	Χ
-	3.0SMCJ8.0CA	-	3DDR	8.00	8.89	9.83	1	13.6	220.6	17.57	1103.0	50	0.064	Χ
-	3.0SMCJ8.5CA	-	3DDT	8.50	9.44	10.40	1	14.4	208.3	18.60	1041.5	20	0.066	Χ
3.0SMCJ9.0A	3.0SMCJ9.0CA	3PDV	3DDV	9.00	10.00	11.10	1	15.4	194.8	19.90	974.0	10	0.069	Χ
3.0SMCJ10A	3.0SMCJ10CA	3PDX	3DDX	10.00	11.10	12.30	1	17.0	176.5	21.96	882.5	5	0.071	X
3.0SMCJ11A	3.0SMCJ11CA	3PDZ	3DDZ	11.00	12.20	13.50	1	18.2	164.8	23.51	824.0	2	0.074	Χ
3.0SMCJ12A	3.0SMCJ12CA	3PEE	3DEE	12.00	13.30	14.70	1	19.9	150.8	25.71	754.0	2	0.075	Χ
3.0SMCJ13A	3.0SMCJ13CA	3PEG	3DEG	13.00	14.40	15.90	1	21.5	139.5	27.78	697.5	2	0.076	Χ
3.0SMCJ14A	3.0SMCJ14CA	3PEK	3DEK	14.00	15.60	17.20	1	23.2	129.3	29.97	646.5	2	0.080	Χ
3.0SMCJ15A	3.0SMCJ15CA	3PEM	3DEM	15.00	16.70	18.50	1	24.4	123.0	31.52	615.0	2	0.083	Χ
3.0SMCJ16A	3.0SMCJ16CA	3PEP	3DEP	16.00	17.80	19.70	1	26.0	115.4	33.59	577.0	2	0.084	Χ
3.0SMCJ17A	3.0SMCJ17CA	3PER	3DER	17.00	18.90	20.90	1	27.6	108.7	35.66	543.5	2	0.085	Χ
3.0SMCJ18A	3.0SMCJ18CA	3PET	3DET	18.00	20.00	22.10	1	29.2	102.7	37.73	513.5	2	0.088	X
3.0SMCJ20A	3.0SMCJ20CA	3PEV	3DEV	20.00	22.20	24.50	1	32.4	92.6	41.86	463.0	2	0.091	Χ
3.0SMCJ22A	3.0SMCJ22CA	3PEX	3DEX	22.00	24.40	26.90	1	35.5	84.5	45.87	422.5	2	0.092	Χ
3.0SMCJ24A	3.0SMCJ24CA	3PEZ	3DEZ	24.00	26.70	29.50	1	38.9	77.1	50.26	385.5	2	0.092	Χ
3.0SMCJ26A	3.0SMCJ26CA	3PFE	3DFE	26.00	28.90	31.90	1	42.1	71.3	54.39	356.5	2	0.093	Χ
3.0SMCJ28A	3.0SMCJ28CA	3PFG	3DFG	28.00	31.10	34.40	1	45.4	66.1	58.66	330.5	2	0.094	Χ
3.0SMCJ30A	3.0SMCJ30CA	3PFK	3DFK	30.00	33.30	36.80	1	48.4	62.0	62.53	310.0	2	0.096	X
3.0SMCJ33A	3.0SMCJ33CA	3PFM	3DFM	33.00	36.70	40.60	1	53.3	56.3	68.86	281.5	2	0.097	Χ
3.0SMCJ36A	3.0SMCJ36CA	3PFP	3DFP	36.00	40.00	44.20	1	58.1	51.6	75.06	258.0	2	0.098	Χ
3.0SMCJ40A	3.0SMCJ40CA	3PFR	3DFR	40.00	44.40	49.10	1	64.5	46.5	83.33	232.5	2	0.099	Χ
-	3.0SMCJ43CA	-	3DFT	43.00	47.80	52.80	1	69.4	43.2	89.66	216.0	2	0.100	Χ
-	3.0SMCJ45CA	-	3DFV	45.00	50.00	55.30	1	72.7	41.3	93.93	206.5	2	0.101	Χ
-	3.0SMCJ48CA	-	3DFX	48.00	53.30	58.90	1	77.4	38.8	100.00	194.0	2	0.101	X
-	3.0SMCJ51CA	-	3DFZ	51.00	56.70	62.70	1	82.4	36.4	106.46	182.0	2	0.101	Χ
-	3.0SMCJ54CA	-	3DGE	54.00	60.00	66.30	1	87.1	34.4	112.53	172.0	2	0.102	X
-	3.0SMCJ58CA	-	3DGG	58.00	64.40	71.20	1	93.6	32.1	120.93	160.5	2	0.103	X

#### Notes



<sup>1.</sup>  $\rm V_{BR}$  measured after  $\rm I_T$  applied for 300µs,  $\rm I_T$  = square wave pulse or equivalent.

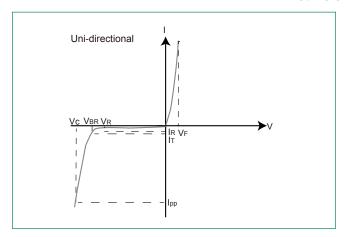
<sup>2.</sup> Surge current waveform per 10µs/1000µs exponential wave and derated per Fig. 2

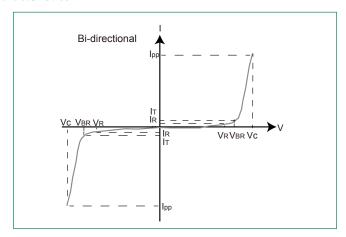
<sup>3.</sup> All terms and symbols are consistent with ANSI/IEEE C62.35  $\,$ 

## 3.0SMCJ Series

Surface Mount - 3000W - D0-214AB

## **I-V Curve Characteristics**





- P<sub>PPM</sub> Peak Pulse Power Dissipation -- Max power dissipation
- Stand-off Voltage Maximum voltage that can be applied to the TVS without operation
- $\textbf{Breakdown Voltage} \text{ Maximum voltage that flows though the TVS at a specified test current (I_T)}$

- Forward Voltage Drop for Uni-directional

## Ratings and Characteristic Curves (T<sub>a</sub>=25°C unless otherwise noted)



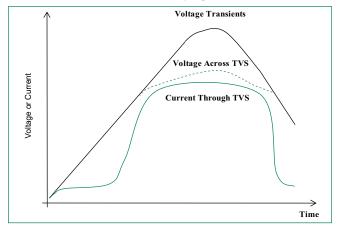
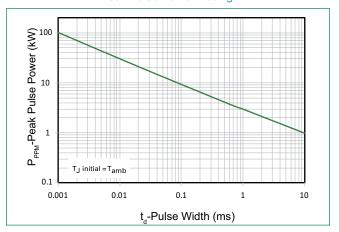


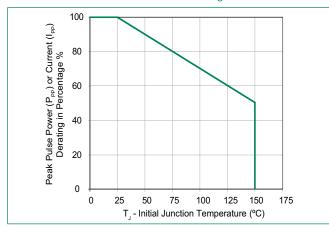
Figure 2: Peak Pulse Power Rating



## 3.0SMCJ Series

## Surface Mount - 3000W - DO-214AB

**Figure 3:** Peak Pulse Power Derating Curve



**Figure 4:** Pulse Waveform

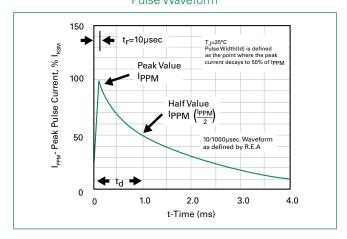
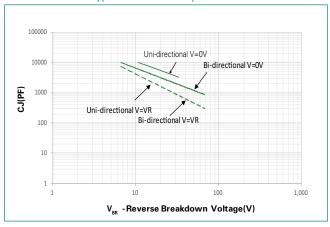


Figure 5:
Typical Junction Capacitance



**Figure 6:**Typical Transient Thermal Impedance

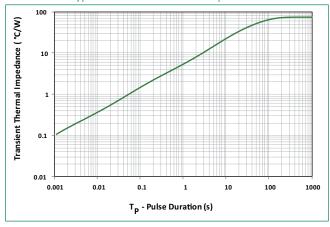


Figure 7:

Maximum Non-Repetitive Peak Forward Surge
Current Uni-Directional Only

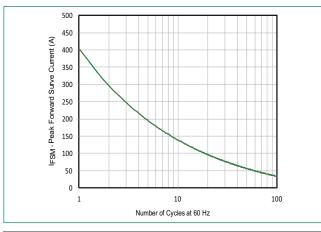
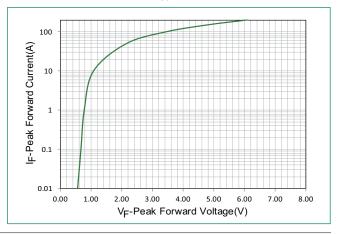


Figure 8:
Peak Forward Voltage Drop vs Peak Forward
Current (Typical Values)

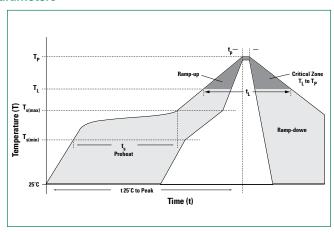




# 3.0SMCJ Series Surface Mount – 3000W – DO-214AB

## **Soldering Parameters**

Reflow Cond	Lead-free assembly		
	-Temperature Min (T <sub>s(min)</sub> )	150°C	
Pre Heat	-Temperature Max (T <sub>s(max)</sub> )	200°C	
	-Time (min to max) (t <sub>s</sub> )	60-120 secs	
Average ram	3°C/second max		
T <sub>S(max)</sub> to T <sub>A</sub> -	3°C/second max		
Reflow	-Temperature (T <sub>L</sub> ) (Liquidus)	217°C	
	-Time (min to max) (T <sub>s</sub> )	60 - 150 seconds	
Peak Tempera	260 <sup>+0/-5</sup> °C		
Time within	30 seconds		
Ramp-down	6°C/second max		
Time 25°C to	8 minutes Max.		
Do not excee	ed	260°C	



## **Physical Specifications**

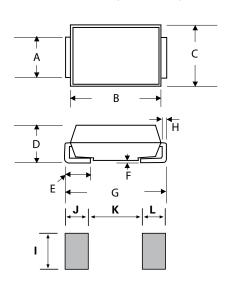
Weight	0.007 ounce, 0.21 grams
Case	JEDEC DO214AB. Molded plastic body over glass passivated junction
Terminal	Matte Tin-plated leads, Solderable per

## **Environmental Specifications**

High Temp. Storage	JESD22-A103
HTRB	JESD22-A108
Temperature Cycling	JESD22-A104
MSL	JEDEC-J-STD-020, LEVEL 1
H3TRB	JESD22-A101
RSH	JESD22-A111

## **Dimensions**

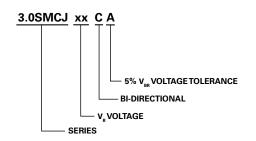
## DO-214AB (SMC J-Bend)

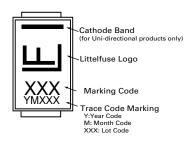


Dii	Inc	hes	Millimeters		
Dimensions	Min	Max	Min	Max	
А	0.114	0.126	2.900	3.200	
В	0.260	0.280	6.600	7.110	
С	0.220	0.245	5.590	6.220	
D	0.079	0.103	2.060	2.620	
Е	0.030	0.060	0.760	1.520	
F	-	0.008	-	0.203	
G	0.305	0.320	7.750	8.130	
Н	0.006	0.012	0.152	0.305	
1	0.129	-	3.300	-	
J	0.094	-	2.400	-	
K	-	0.165	-	4.200	
L	0.094	-	2.400	-	



## **Part Marking System**

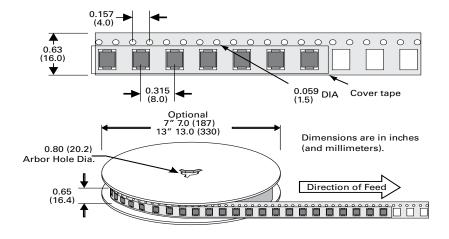




## **Packing Options**

Part Number	Component Package	Quantity	Packaging Option	Packaging Specification
3.0SMCJxxXX	DO-214AB	3000	Tape & Reel - 16mm tape/13" reel	EIA-481

## **Tape and Reel Specification**



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